

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in this application.

Listing of Claims:

1. (Original) A method for temperature compensation for a memory cell with temperature-dependent behavior, the method comprising:
 - (a) generating at least one of a first temperature-dependent reference voltage comprising a negative temperature coefficient and a second temperature-dependent reference voltage comprising a positive temperature coefficient;
 - (b) generating one of a wordline voltage and a bitline voltage from one of the at least one of the first and second temperature-dependent reference voltages;
 - (c) generating the other of the wordline and bitline voltages; and
 - (d) applying the wordline and bitline voltages across a memory cell.
2. (Original) The invention of Claim 1, wherein (a) comprises generating both the first and second temperature-dependent reference voltages, and wherein (c) comprises generating the other of the wordline and bitline voltages from the other of the at least one of the first and second temperature-dependent reference voltages.
3. (Original) The method of Claim 1, wherein (d) is performed during a write operation.

4. (Original) The method of Claim 1, wherein (d) is performed during a read operation.
5. (Original) The method of Claim 1, wherein the temperature coefficient(s) of the at least one of the first and second temperature-dependent reference voltages are chosen such that a voltage across the memory cell comprises a negative temperature coefficient.
6. (Original) The method of Claim 1, wherein the memory cell comprises a write-once memory cell.
7. (Original) The method of Claim 1, wherein the memory cell comprises a write-many memory cell.
8. (Original) The method of Claim 1, wherein the memory cell is part of a two-dimensional memory array.
9. (Original) The method of Claim 1, wherein the memory cell is part of a three-dimensional memory array.
10. (Original) The method of Claim 1, wherein the memory cell comprises a non-volatile memory cell.
11. (Original) A system for temperature compensation for a memory cell with temperature-dependent behavior, the system comprising:

a first temperature-dependent reference voltage source operative to generate a first temperature-dependent reference voltage comprising a negative temperature coefficient;

a second temperature-dependent reference voltage source operative to generate a second temperature-dependent reference voltage comprising a positive temperature coefficient;

a wordline voltage regulator operative to generate a wordline voltage from one of the first and second temperature-dependent reference voltages;

a bitline voltage regulator operative to generate a bitline voltage from the other of the first and second temperature-dependent reference voltages; and

a memory cell coupled with the wordline and bitline voltage regulators.

12. (Original) The system of Claim 11 further comprising:

a temperature-dependent current source operative to generate a first reference current with a negative temperature coefficient; and

a temperature-independent current source operative to generate a second reference current;

wherein the first and second temperature-dependent reference voltage sources generate the first and second temperature-dependent reference voltages, respectively, from the first and second reference currents.

13. (Original) The system of Claim 11, wherein at least one of the temperature-dependent current source, the first temperature-dependent reference voltage source, and the second temperature-dependent reference voltage source comprises a temperature-dependent resistor.

14. (Original) The system of Claim 11, wherein at least one of the temperature-dependent current source, the first temperature-dependent reference voltage source, and the second temperature-dependent reference voltage source comprises a temperature-independent resistor.

15. (Original) The system of Claim 11, wherein the temperature coefficients of the first and second reference voltages are chosen such that a voltage across the memory cell comprises a negative temperature coefficient.

16. (Original) The system of Claim 11, wherein the memory cell comprises a write-once memory cell.

17. (Original) The system of Claim 11, wherein the memory cell comprises a write-many memory cell.

18. (Original) The system of Claim 11, wherein the memory cell is part of a two-dimensional memory array.

19. (Original) The system of Claim 11, wherein the memory cell is part of a three-dimensional memory array.

20. (Original) The system of Claim 11, wherein the memory cell comprises a non-volatile memory cell.

21. (Previously Presented) A system for sensing a memory cell comprising temperature-dependent behavior, the system comprising:
- a memory cell comprising temperature-dependent behavior;
- a current sensing amplifier coupled with the memory cell; and
- a temperature-dependent reference current source coupled with the current sensing amplifier, wherein the temperature-dependent reference current source comprises a plurality of memory cells that have the same temperature-dependent behavior as the memory cell, wherein each of the plurality of memory cells generates a current when a voltage is applied to the plurality of memory cells, and wherein the temperature-dependent reference current source generates a current reference from an average of the currents generated by the plurality of memory cells;
- wherein the current sensing amplifier compares the current reference to current sensed back from the memory cell during a read operation to determine whether the memory cell is programmed.
22. (Previously Presented) The system of Claim 21 further comprising a programmable mirror interposed between the plurality of memory cells and the current sensing amplifier.
23. (Original) The system of Claim 21, wherein the memory cell comprises a write-once memory cell.

24. (Original) The system of Claim 21, wherein the memory cell comprises a write-many memory cell.

25. (Original) The system of Claim 21, wherein the memory cell is part of a two-dimensional memory array.

26. (Original) The system of Claim 21, wherein the memory cell is part of a three-dimensional memory array.

27. (Original) The system of Claim 21, wherein the memory cell comprises a non-volatile memory cell.

Claim 28 (Cancelled)

29. (Currently Amended) ~~The system of Claim 28 further comprising: A system for sensing a memory cell comprising temperature-dependent behavior, the system comprising:~~
~~a memory cell comprising temperature-dependent behavior;~~
~~a current sensing amplifier coupled with the memory cell;~~
~~a temperature-dependent reference current source coupled with the current sensing amplifier, the temperature-dependent reference current source operative to generate a temperature-dependent reference current comprising a positive temperature coefficient;~~

wherein the current sensing amplifier compares the temperature-dependent reference current to current sensed back from the memory cell during a read operation to determine whether the memory cell is programmed;

a second temperature-dependent current source, the second temperature-dependent current source operative to generate a reference current with a negative temperature coefficient; and

a temperature-independent current source operative to generate a temperature-independent reference current;

wherein the temperature-dependent reference current source generates the temperature-dependent reference current from the reference current generated by the second temperature-dependent current source and the temperature-independent reference current.

30. (Currently Amended) The system of Claim 28 29, wherein the memory cell comprises a write-once memory cell.

31. (Currently Amended) The system of Claim 28 29, wherein the memory cell comprises a write-many memory cell.

32. (Currently Amended) The system of Claim 28 29, wherein the memory cell is part of a two-dimensional memory array.

33. (Currently Amended) The system of Claim 28 29, wherein the memory cell is part of a three-dimensional memory array.

34. (Currently Amended) The system of Claim 28 29, wherein the memory cell comprises a non-volatile memory cell.